

C1812C563JCRACTU

Aliases (C1812C563JCRAC7800)

Specifications

Insulation Resistance

SMD Comm X7R HV, Ceramic, 0.056 uF, 5%, 500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	95 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1.4mm +/-0.15mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

Cap	acitance	0.056 uF
Mea	surement Condition	1 kHz 1.0Vrms
Tole	erance	5%
Volt	age DC	500 VDC
Diel	ectric Withstanding Voltage	750 VDC
Tem	perature Range	-55/+125°C
Tem	np. Coefficient	X7R
Refe	acitance Change with erence to +25°C and 0 VDC lied (TCC)	15%, 1kHz 1.0Vrms
Diss	ipation Factor	2.5%1kHz1.0Vrms
Agir	ng Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

1.7857 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

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